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# Detection Learning Style Vark For Out Of School Children (OSC)

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## **Abstract**

Learning style is different for every learner especially for out of school children or OSC. They are not like formal students, they are learners but they don't have a teacher as a guide for learning. Elearning is one of the solutions to help OSC to get education. E-learning should have preferred learning styles of learners. Data for identifying the learning style in this study were collected with a VARK questionnaire from 25 OSC in junior high school level from 5 municipalities in Palembang. The validity of the questionnaire was considered on basis of experts' views and its reliability was calculated by using Cronbach's alpha coefficients ( $\alpha$ =0.68). Overall, 55% preferred to use a single

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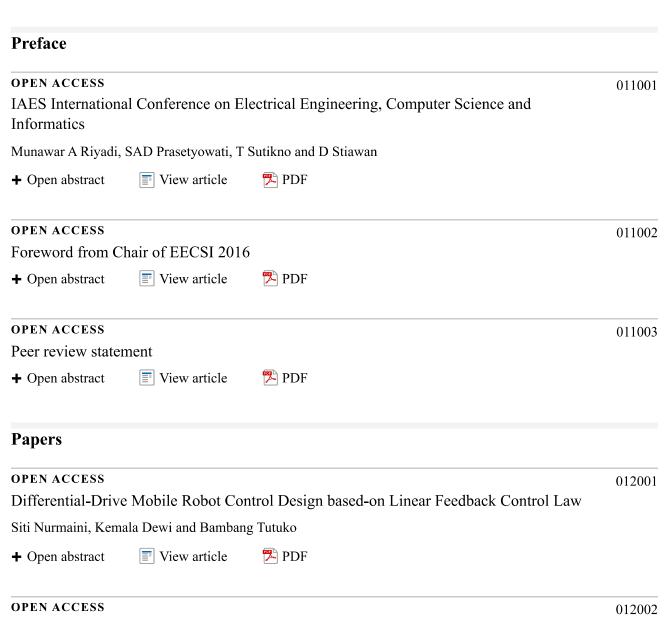
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